

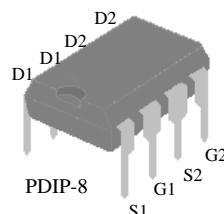


## ▼ Simple Drive Requirement

## ▼ Lower Gate Charge

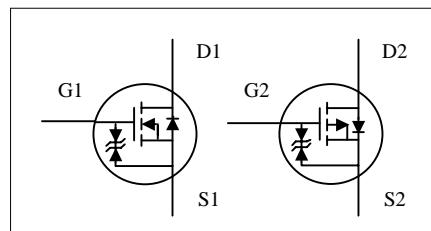
## ▼ Fast Switching Performance

## ▼ RoHS Compliant

**Description**

The Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

|      |              |      |
|------|--------------|------|
| N-CH | $BV_{DSS}$   | 40V  |
|      | $R_{DS(ON)}$ | 28mΩ |
|      | $I_D$        | 6A   |
| P-CH | $BV_{DSS}$   | -40V |
|      | $R_{DS(ON)}$ | 42mΩ |
|      | $I_D$        | -5A  |

**Absolute Maximum Ratings**

| Symbol                   | Parameter                             | Rating     |           | Units |
|--------------------------|---------------------------------------|------------|-----------|-------|
|                          |                                       | N-channel  | P-channel |       |
| $V_{DS}$                 | Drain-Source Voltage                  | 40         | -40       | V     |
| $V_{GS}$                 | Gate-Source Voltage                   | $\pm 16$   | $\pm 16$  | V     |
| $I_D @ T_A = 25^\circ C$ | Continuous Drain Current <sup>3</sup> | 6.0        | -5.0      | A     |
| $I_D @ T_A = 70^\circ C$ | Continuous Drain Current <sup>3</sup> | 5.0        | -4.0      | A     |
| $I_{DM}$                 | Pulsed Drain Current <sup>1</sup>     | 30         | -30       | A     |
| $P_D @ T_A = 25^\circ C$ | Total Power Dissipation               | 2.0        |           | W     |
|                          | Linear Derating Factor                | 0.016      |           | W/°C  |
| $T_{STG}$                | Storage Temperature Range             | -55 to 150 |           | °C    |
| $T_J$                    | Operating Junction Temperature Range  | -55 to 150 |           | °C    |

**Thermal Data**

| Symbol      | Parameter  | Value | Unit      |
|-------------|--|-------|-----------|
| $R_{thj-a}$ | Thermal Resistance Junction-ambient <sup>3</sup> | Max.  | 62.5 °C/W |



## N-CH Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                                     | Parameter   | Test Conditions   | Min. | Typ. | Max.     | Units                     |
|--|---|---|------|------|----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                          | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$      | 40   | -    | -        | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient               | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=1\text{mA}$ | -    | 0.03 | -        | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS}(\text{ON})}$                 | Static Drain-Source On-Resistance <sup>2</sup>          | $V_{\text{GS}}=10\text{V}, I_{\text{D}}=6\text{A}$          | -    | -    | 28       | $\text{m}\Omega$          |
|  |   | $V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=4\text{A}$         | -    | -    | 36       | $\text{m}\Omega$          |
| $V_{\text{GS}(\text{th})}$                 | Gate Threshold Voltage                                  | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$  | 1    | -    | 3        | V                         |
| $g_{\text{fs}}$                            | Forward Transconductance                                | $V_{\text{DS}}=10\text{V}, I_{\text{D}}=6\text{A}$          | -    | 6    | -        | S                         |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current ( $T_j=25^\circ\text{C}$ ) | $V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -    | 1        | $\mu\text{A}$             |
|  | Drain-Source Leakage Current ( $T_j=70^\circ\text{C}$ ) | $V_{\text{DS}}=32\text{V}, V_{\text{GS}}=0\text{V}$         | -    | -    | 25       | $\mu\text{A}$             |
| $I_{\text{GSS}}$                           | Gate-Source Leakage                                     | $V_{\text{GS}}=\pm 16\text{V}$                              | -    | -    | $\pm 30$ | $\mu\text{A}$             |
| $Q_g$                                      | Total Gate Charge <sup>2</sup>                          | $I_{\text{D}}=6\text{A}$                                    | -    | 8.2  | 13       | nC                        |
| $Q_{\text{gs}}$                            | Gate-Source Charge                                      | $V_{\text{DS}}=20\text{V}$                                  | -    | 1.5  | -        | nC                        |
| $Q_{\text{gd}}$                            | Gate-Drain ("Miller") Charge                            | $V_{\text{GS}}=4.5\text{V}$                                 | -    | 3.6  | -        | nC                        |
| $t_{\text{d}(\text{on})}$                  | Turn-on Delay Time <sup>2</sup>                         | $V_{\text{DS}}=20\text{V}$                                  | -    | 7    | -        | ns                        |
| $t_r$                                      | Rise Time   | $I_{\text{D}}=6\text{A}$                                    | -    | 20   | -        | ns                        |
| $t_{\text{d}(\text{off})}$                 | Turn-off Delay Time                                     | $R_G=3\Omega, V_{\text{GS}}=10\text{V}$                     | -    | 20   | -        | ns                        |
| $t_f$                                      | Fall Time   | $R_D=3.3\Omega$   | -    | 4    | -        | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance                                       | $V_{\text{GS}}=0\text{V}$                                   | -    | 590  | 940      | pF                        |
| $C_{\text{oss}}$                           | Output Capacitance                                      | $V_{\text{DS}}=20\text{V}$                                  | -    | 110  | -        | pF                        |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                            | $f=1.0\text{MHz}$   | -    | 80   | -        | pF                        |
| $R_g$                                      | Gate Resistance   | $f=1.0\text{MHz}$   | -    | 2    | 3        | $\Omega$                  |

## Source-Drain Diode

| Symbol          | Parameter                          | Test Conditions                             | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|---|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_S=1.25\text{A}, V_{\text{GS}}=0\text{V}$ | -    | -    | 1.6  | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_S=6\text{A}, V_{\text{GS}}=0\text{V}$    | -    | 20   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            | $dI/dt=100\text{A}/\mu\text{s}$             | -    | 12   | -    | nC    |



## P-CH Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

| Symbol                                     | Parameter   | Test Conditions  | Min. | Typ.  | Max.     | Units                     |
|--|---|--|------|-------|----------|---------------------------|
| $\text{BV}_{\text{DSS}}$                   | Drain-Source Breakdown Voltage                          | $V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=-250\mu\text{A}$     | -40  | -     | -        | V                         |
| $\Delta \text{BV}_{\text{DSS}}/\Delta T_j$ | Breakdown Voltage Temperature Coefficient               | Reference to $25^\circ\text{C}$ , $I_{\text{D}}=-1\text{mA}$   | -    | -0.03 | -        | $\text{V}/^\circ\text{C}$ |
| $R_{\text{DS(ON)}}$                        | Static Drain-Source On-Resistance <sup>2</sup>          | $V_{\text{GS}}=-10\text{V}$ , $I_{\text{D}}=-5\text{A}$        | -    | -     | 42       | $\text{m}\Omega$          |
|  |   | $V_{\text{GS}}=-4.5\text{V}$ , $I_{\text{D}}=-3\text{A}$       | -    | -     | 60       | $\text{m}\Omega$          |
| $V_{\text{GS(th)}}$                        | Gate Threshold Voltage                                  | $V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=-250\mu\text{A}$ | -0.8 | -     | -2.5     | V                         |
| $g_{\text{fs}}$                            | Forward Transconductance                                | $V_{\text{DS}}=-10\text{V}$ , $I_{\text{D}}=-5\text{A}$        | -    | 5     | -        | S                         |
| $I_{\text{DSS}}$                           | Drain-Source Leakage Current ( $T_j=25^\circ\text{C}$ ) | $V_{\text{DS}}=-40\text{V}$ , $V_{\text{GS}}=0\text{V}$        | -    | -     | -1       | $\text{uA}$               |
|  | Drain-Source Leakage Current ( $T_j=70^\circ\text{C}$ ) | $V_{\text{DS}}=-32\text{V}$ , $V_{\text{GS}}=0\text{V}$        | -    | -     | -25      | $\text{uA}$               |
| $I_{\text{GSS}}$                           | Gate-Source Leakage                                     | $V_{\text{GS}}=\pm 16\text{V}$                                 | -    | -     | $\pm 30$ | $\text{uA}$               |
| $Q_g$                                      | Total Gate Charge <sup>2</sup>                          | $I_{\text{D}}=-5\text{A}$                                      | -    | 9     | 24       | nC                        |
| $Q_{\text{gs}}$                            | Gate-Source Charge                                      | $V_{\text{DS}}=-20\text{V}$                                    | -    | 2     | -        | nC                        |
| $Q_{\text{gd}}$                            | Gate-Drain ("Miller") Charge                            | $V_{\text{GS}}=-4.5\text{V}$                                   | -    | 5     | -        | nC                        |
| $t_{\text{d(on)}}$                         | Turn-on Delay Time <sup>2</sup>                         | $V_{\text{DS}}=-20\text{V}$                                    | -    | 8.5   | -        | ns                        |
| $t_r$                                      | Rise Time   | $I_{\text{D}}=-5\text{A}$                                      | -    | 15    | -        | ns                        |
| $t_{\text{d(off)}}$                        | Turn-off Delay Time                                     | $R_G=3\Omega$ , $V_{\text{GS}}=-10\text{V}$                    | -    | 27    | -        | ns                        |
| $t_f$                                      | Fall Time   | $R_D=4\Omega$  | -    | 25    | -        | ns                        |
| $C_{\text{iss}}$                           | Input Capacitance                                       | $V_{\text{GS}}=0\text{V}$                                      | -    | 770   | 1230     | pF                        |
| $C_{\text{oss}}$                           | Output Capacitance                                      | $V_{\text{DS}}=-20\text{V}$                                    | -    | 165   | -        | pF                        |
| $C_{\text{rss}}$                           | Reverse Transfer Capacitance                            | f=1.0MHz   | -    | 115   | -        | pF                        |
| $R_g$                                      | Gate Resistance   | f=1.0MHz   | -    | 6     | 9        | $\Omega$                  |

## Source-Drain Diode

| Symbol          | Parameter                          | Test Conditions  | Min. | Typ. | Max. | Units |
|-----------------|------------------------------------|--|------|------|------|-------|
| $V_{\text{SD}}$ | Forward On Voltage <sup>2</sup>    | $I_{\text{S}}=-1.25\text{A}$ , $V_{\text{GS}}=0\text{V}$ | -    | -    | -1.6 | V     |
| $t_{\text{rr}}$ | Reverse Recovery Time <sup>2</sup> | $I_{\text{S}}=-5\text{A}$ , $V_{\text{GS}}=0\text{V}$    | -    | 20   | -    | ns    |
| $Q_{\text{rr}}$ | Reverse Recovery Charge            | dl/dt=-100A/ $\mu\text{s}$                               | -    | 16   | -    | nC    |

## Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
- 3.Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board, t  $\leq 10\text{sec}$  ;  $90^\circ\text{C}/\text{W}$  when mounted on min. copper pad.



## N-Channel

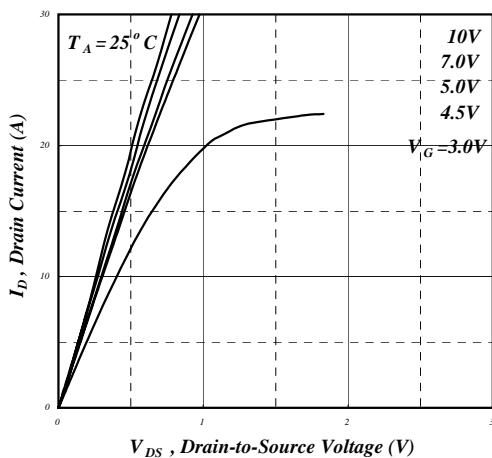


Fig 1. Typical Output Characteristics

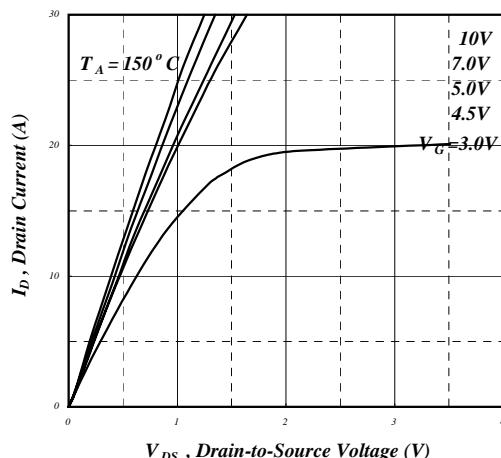


Fig 2. Typical Output Characteristics

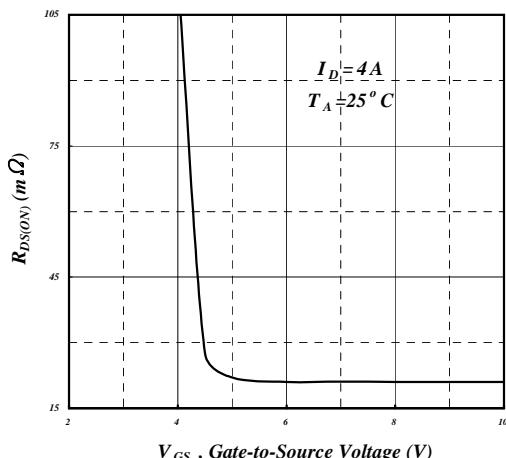


Fig 3. On-Resistance v.s. Gate Voltage

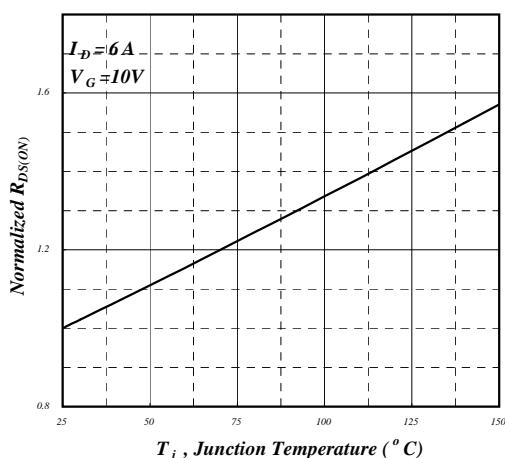


Fig 4. Normalized On-Resistance v.s. Junction Temperature

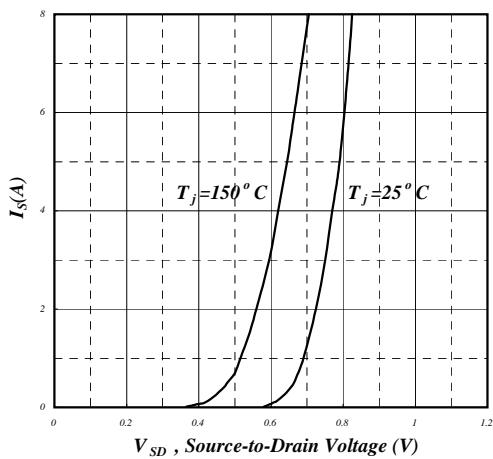


Fig 5. Forward Characteristic of Reverse Diode

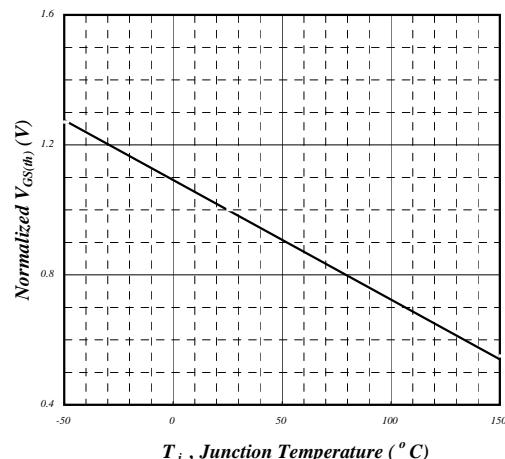


Fig 6. Gate Threshold Voltage v.s. Junction Temperature



## N-Channel

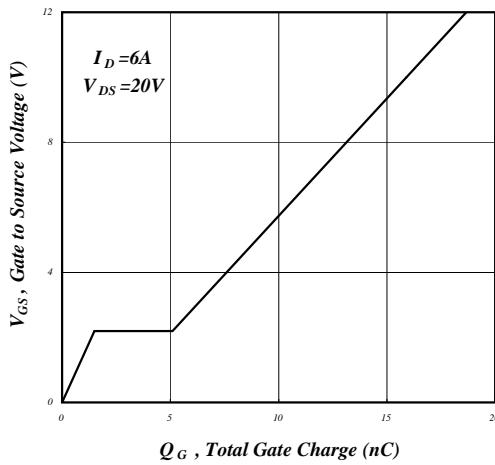


Fig 7. Gate Charge Characteristics

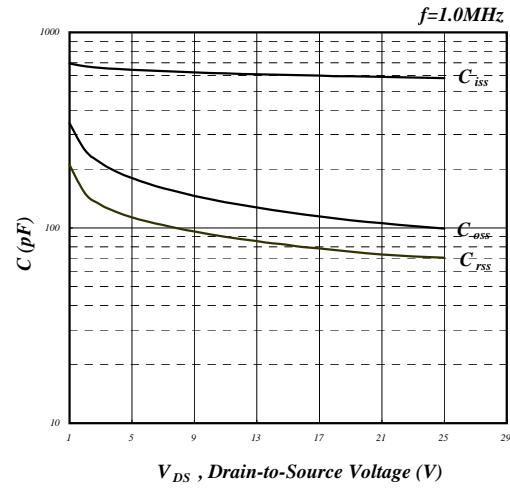


Fig 8. Typical Capacitance Characteristics

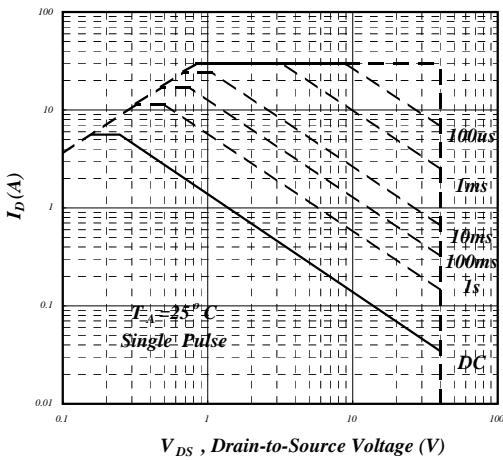


Fig 9. Maximum Safe Operating Area

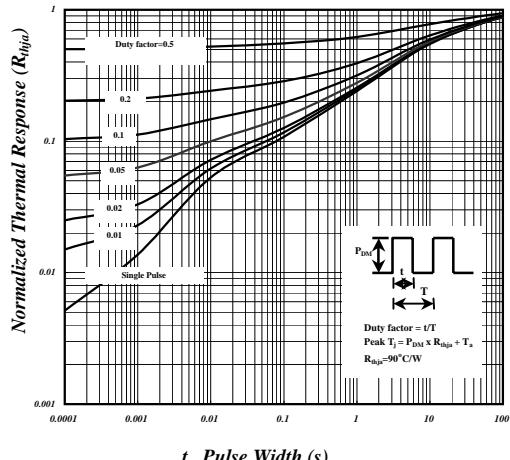


Fig 10. Effective Transient Thermal Impedance

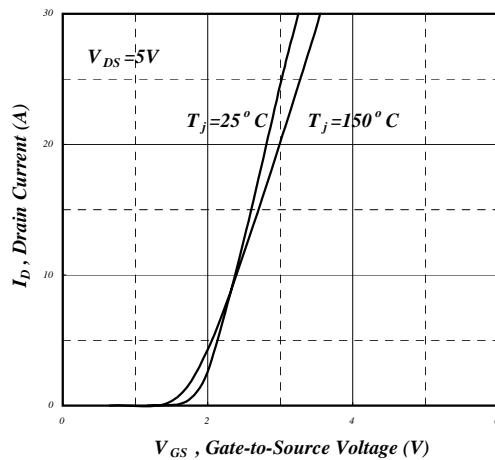


Fig 11. Transfer Characteristics

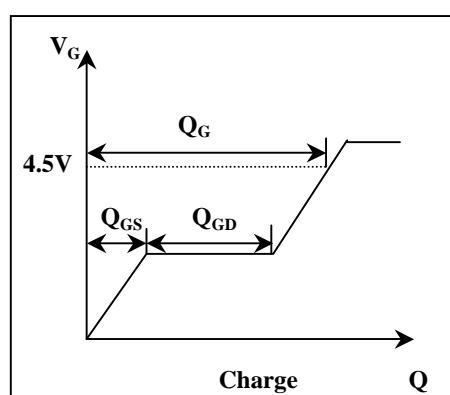
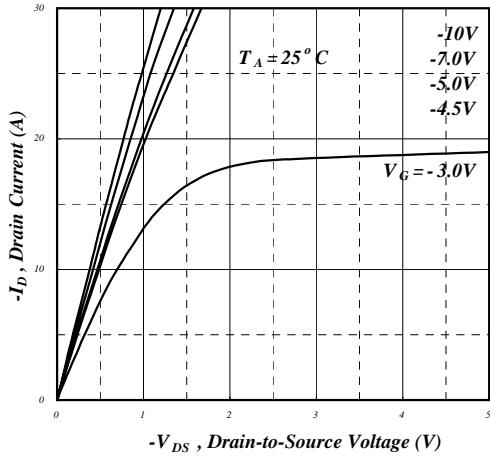


Fig 12. Gate Charge Waveform

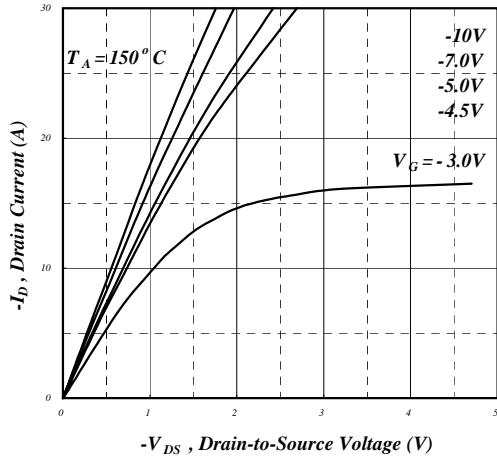


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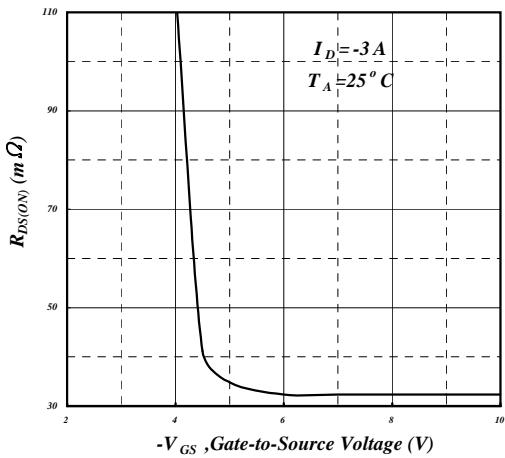
### P-Channel



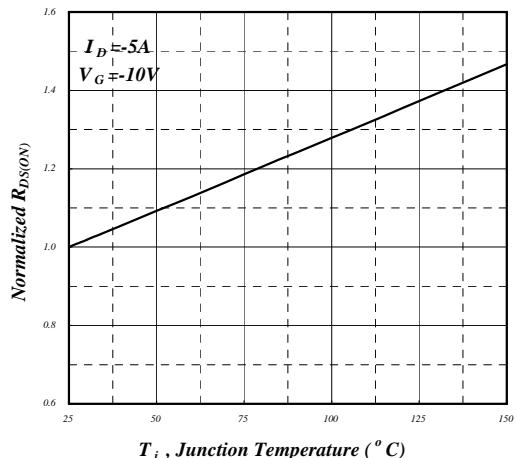
**Fig 1. Typical Output Characteristics**



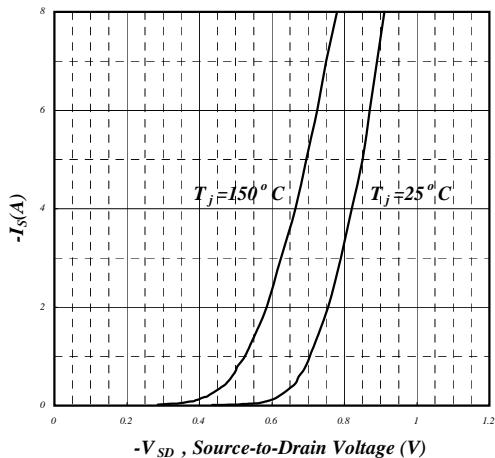
**Fig 2. Typical Output Characteristics**



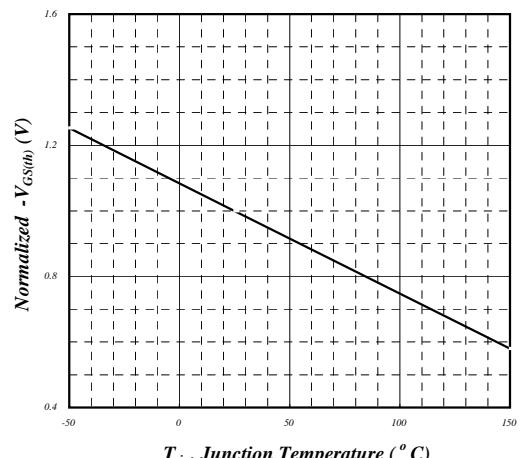
**Fig 3. On-Resistance v.s. Gate Voltage**



**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



**Fig 5. Forward Characteristic of Reverse Diode**



**Fig 6. Gate Threshold Voltage v.s. Junction Temperature**



## P-Channel

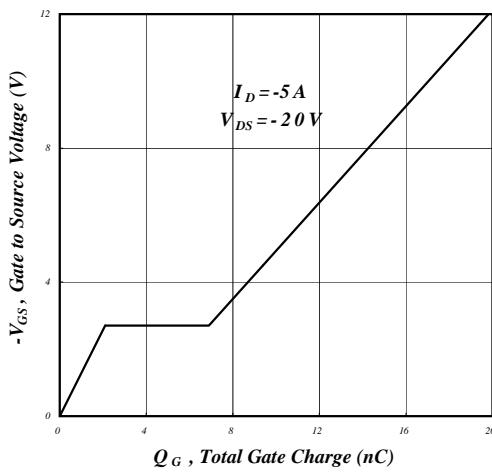


Fig 7. Gate Charge Characteristics

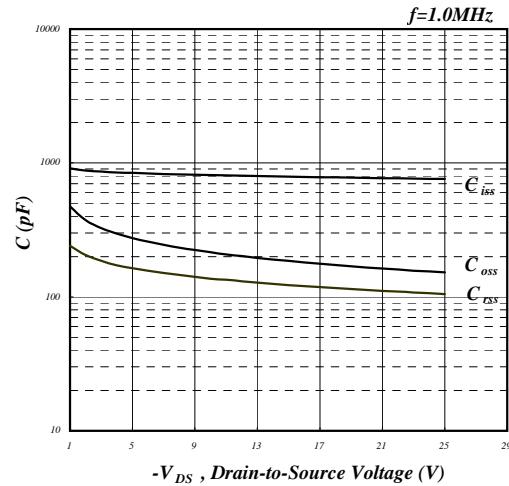


Fig 8. Typical Capacitance Characteristics

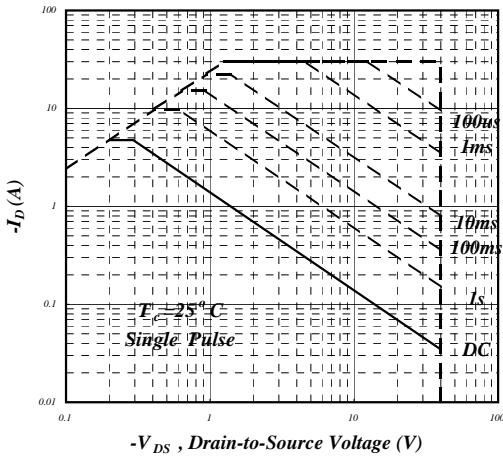


Fig 9. Maximum Safe Operating Area

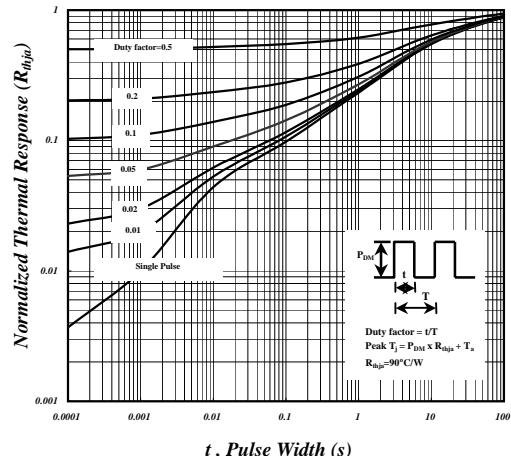


Fig 10. Effective Transient Thermal Impedance

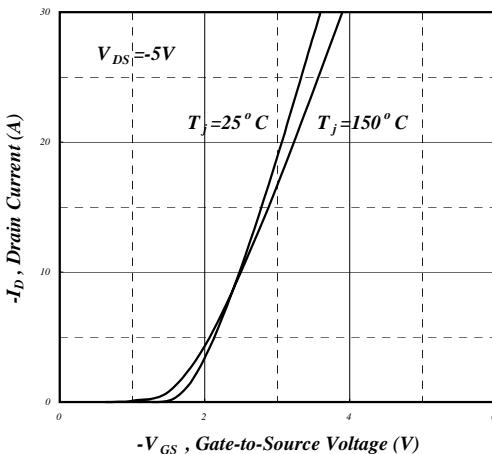


Fig 11. Transfer Characteristics

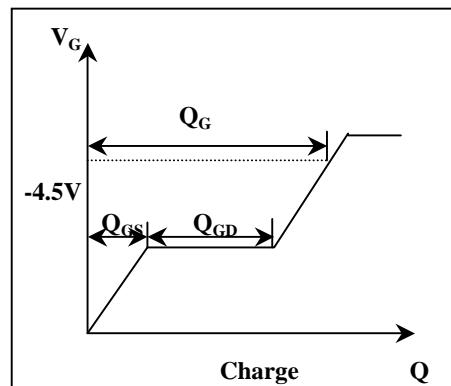


Fig 12. Gate Charge Waveform